

# NOT RECOMMENDED FOR NEW DESIGN CONTACT US



DMT6009LJ3

#### **60V N-CHANNEL ENHANCEMENT MODE MOSFET**

### **Product Summary**

BV <sub>DSS</sub>	R <sub>DS(ON)</sub> Max	I <sub>D</sub> T <sub>C</sub> = +25°C
60V	$10m\Omega$ @ V <sub>GS</sub> = $10V$	74.5A
	12.8mΩ @ V <sub>GS</sub> = 4.5V	65.8A

### **Description and Applications**

This new generation MOSFET is designed to minimize the on-state resistance (R<sub>DS(ON)</sub>) yet maintain superior switching performance, making it ideal for high-efficiency power-management applications.

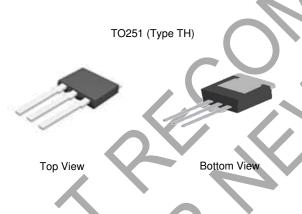
- Power management functions
- DC-DC converters
- Backlighting

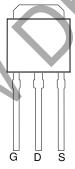
### **Features and Benefits**

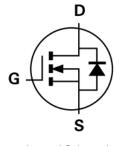
- 100% Unclamped Inductive Switching Ensures More Reliable and Robust End Application
- Low Rds(ON)—Ensures On State Losses Are Minimized
- Excellent Q<sub>gd x</sub> R<sub>DS(ON)</sub> Product (FOM)
- Advanced Technology for DC-DC Converters
- Small Form Factor Thermally Efficient Package Enables Higher Density End Products
- Lead-Free Finish; RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- For automotive applications requiring specific change control (i.e. parts qualified to AEC-Q100/101/104/200, PPAP capable, and manufactured in IATF 16949 certified facilities), please contact us or your local Diodes representative. https://www.diodes.com/quality/product-definitions/

#### **Mechanical Data**

- Package: TO251
- Package Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminal Connections: See Diagram
- Terminals: Finish Matte Tin Annealed over Copper Leadframe. Solderable per MIL-STD-202, Method 208 @3
- Weight: 0.33 grams (Approximate)







Top View Pin Configuration

Internal Schematic

### **Ordering Information** (Note 4)

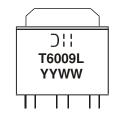
Part Number	Part Number Peakage		Packing		
Part Number	Package	Qty.	Carrier		
DMT6009LJ3	TO251 (Type TH)	75 Pieces	Tube		

Notes:

- 1. EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3).compliant. All applicable RoHS exemptions applied.

  2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.

# **Marking Information**



T6009L = Product Type Marking Code
YYWW = Date Code Marking
YY = Last Two Digits of Year (ex: 22 = 2022)
WW or WW = Week Code (01 to 53)



# **Maximum Ratings** (@ $T_A = +25$ °C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit	
Drain-Source Voltage	VDSS	60	V	
Gate-Source Voltage			±16	V
Continuous Drain Current (Note 7)	$T_C = +25$ °C $T_C = +70$ °C	I <sub>D</sub>	74.5 59.6	А
Maximum Body Diode Forward Current (Note 7)		ls	50	Α
Pulsed Drain Current (10µs Pulse, Duty Cycle = 1%)	I <sub>DM</sub>	280	Α	
Pulsed Body Diode Forward Current (10µs Pulse, Duty Cycle = 1%)	I <sub>SM</sub>	280	Α	
Avalanche Current, L=0.1mH	I <sub>AS</sub>	28.2	Α	
Avalanche Energy, L=0.1mH		Eas	39.8	mJ

## **Thermal Characteristics**

Characteristic		Symbol	Value	Unit
Total Power Dissipation (Note 6)	T <sub>A</sub> = +25°C	Pp	2.9	W
Thermal Resistance, Junction to Ambient (Note 6)		Reja	43	°C/W
Thermal Resistance, Junction to Ambient (Note 5)		Reja	80	°C/W
Total Power Dissipation (Note 7)	$T_C = +25^{\circ}C$	P <sub>D</sub>	83.3	W
Thermal Resistance, Junction to Case (Note 7)		Rejc	1.5	°C/W
Operating and Storage Temperature Range		TJ, TSTG	-55 to +150	°C

# Electrical Characteristics (@TA = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition	
OFF CHARACTERISTICS (Note 8)							
Drain-Source Breakdown Voltage	BVDSS	60	_		V	$V_{GS} = 0V$ , $I_D = 1mA$	
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	1	_	1	μΑ	V <sub>DS</sub> = 48V, V <sub>GS</sub> = 0V	
Gate-Source Leakage	Igss	<b>1</b>	1	±100	nA	V <sub>GS</sub> = ±16V, V <sub>DS</sub> = 0V	
ON CHARACTERISTICS (Note 8)							
Gate Threshold Voltage	V <sub>GS(TH)</sub>	0.7		2	V	$V_{DS} = V_{GS}$ , $I_D = 250 \mu A$	
Static Drain-Source On-Resistance	Descrip	-	8	10	mΩ	V <sub>GS</sub> = 10V, I <sub>D</sub> = 13.5A	
Static Drain-Source On-nesistance	RDS(ON)	<b>/</b>	9.8	12.8	11122	V <sub>GS</sub> = 4.5V, I <sub>D</sub> = 11.5A	
Diode Forward Voltage	VsD		0.8	1.2	V	$V_{GS} = 0V$ , $I_{S} = 5A$	
DYNAMIC CHARACTERISTICS (Note 9)							
Input Capacitance	Ciss	_	1925			V <sub>DS</sub> = 30V, V <sub>GS</sub> = 0V, f = 1MHz	
Output Capacitance	Coss	_	438	_	pF		
Reverse Transfer Capacitance	Crss	_	41	_			
Gate Resistance	Rg	_	1.7	_	Ω	$V_{DS} = 0V$ , $V_{GS} = 0V$ , $f = 1MHz$	
Total Gate Charge (V <sub>GS</sub> = 4.5V)	Qg	_	15.6	_			
Total Gate Charge (Vgs = 10V)	Qg	_	33.5	_	nC	V <sub>DS</sub> = 30V, I <sub>D</sub> = 13.5A	
Gate-Source Charge	Qgs	_	4.7	_	IIC		
Gate-Drain Charge	Q <sub>gd</sub>	_	5.3	_			
Turn-On Delay Time	tD(ON)	_	4.5	_		$V_{DD} = 30V, V_{GS} = 10V,$ $R_g = 6\Omega, I_D = 13.5A$	
Turn-On Rise Time	tr	_	8.6	_			
Turn-Off Delay Time	tD(OFF)	_	35.9	_	ns		
Turn-Off Fall Time	t <sub>F</sub>	_	15.7	_			
Body Diode Reverse Recovery Time	trr	_	18.2	_	ns	10.50 11/11 1000/	
Body Diode Reverse Recovery Charge	Qrr	_	33.1	_	nC	I <sub>F</sub> = 13.5A, di/dt = 400A/μs	

Notes:

Device mounted on FR-4 substrate PC board, 2oz copper, with minimum recommended pad layout.
 Device mounted on FR-4 substrate PC board, 2oz copper, with thermal bias to bottom layer 1-inch square copper plate.
 Thermal resistance from junction to soldering point (on the exposed drain pad).
 Short duration pulse test used to minimize self-heating effect.

<sup>9.</sup> Guaranteed by design. Not subject to production testing.



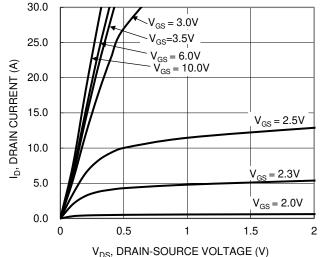


Figure 1. Typical Output Characteristic

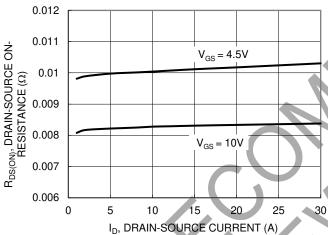


Figure 3. Typical On-Resistance vs. Drain Current and Gate Voltage

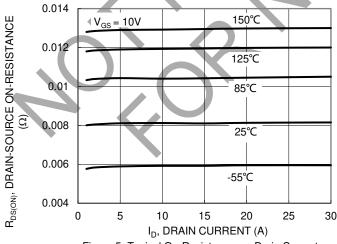
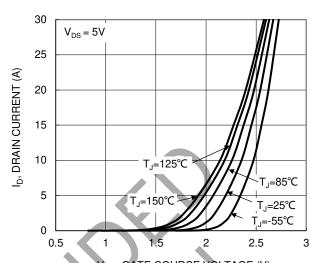


Figure 5. Typical On-Resistance vs. Drain Current and Junction Temperature



V<sub>GS</sub>, GATE-SOURCE VOLTAGE (V) Figure 2. Typical Transfer Characteristic

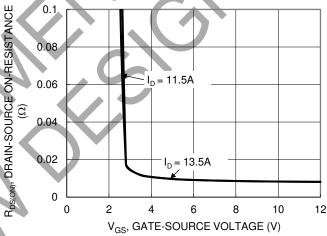
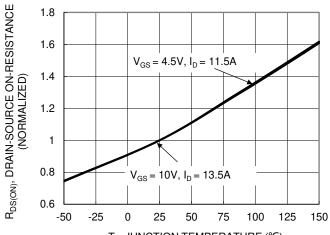


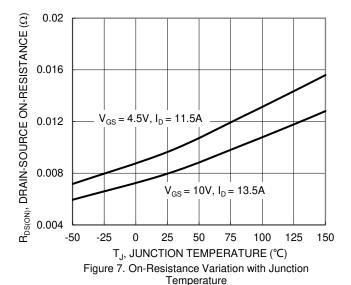
Figure 4. Typical Transfer Characteristic

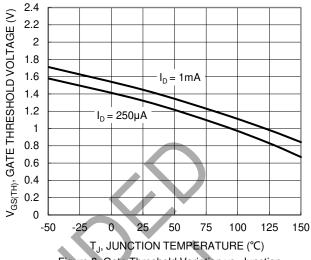


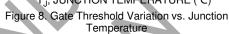
 $T_J$ , JUNCTION TEMPERATURE (°C) Figure 6. On-Resistance Variation with Junction Temperature











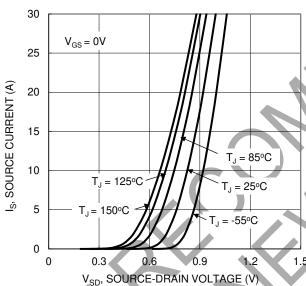


Figure 9. Diode Forward Voltage vs. Current



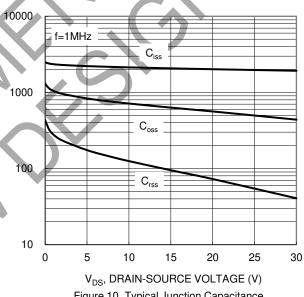
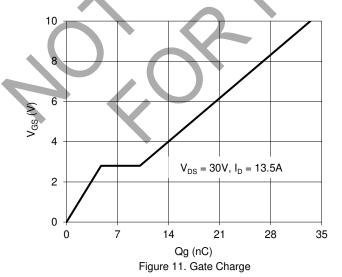
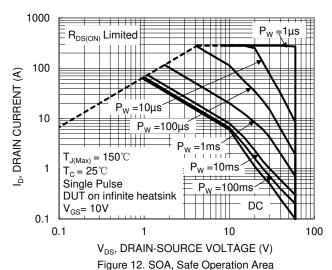
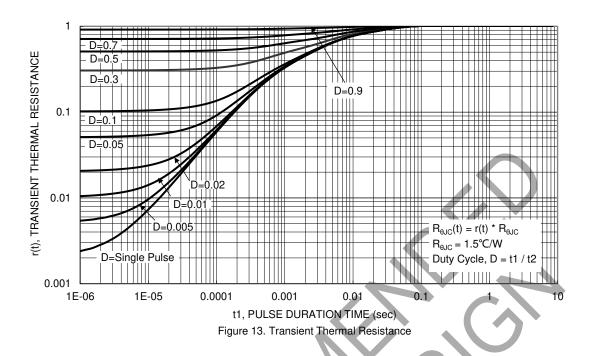


Figure 10. Typical Junction Capacitance





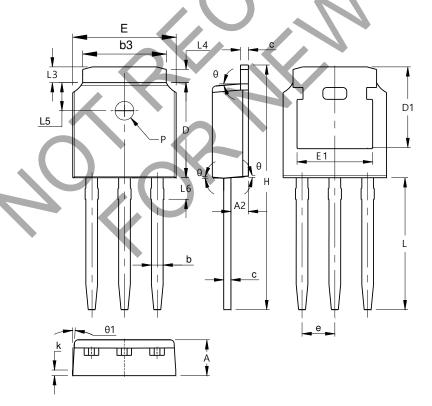




# **Package Outline Dimensions**

Please see http://www.diodes.com/package-outlines.html for the latest version.

TO251 (Type TH)



TO251 (Type TH)						
Dim	Min	Max	Тур			
Α	2.20	2.40	2.30			
A2	0.97	1.17	1.07			
b	0.68	0.90	0.78			
b3	5.20	5.50	5.33			
С	0.43	0.63	0.53			
D	5.98	6.22	6.10			
D1	5	.30 RE	F			
е	2.	286 BS				
Е	6.40	6.80	6.60			
E1	4.63	5.03	4.83			
Н	16.22	16.82	16.52			
k	C	).40REI	F			
L	9.15	9.65	9.40			
L3	0.88	1.28	1.02			
L4	0.75 REF					
L5	1.65	1.95	1.80			
L6	0.85	1.25	1.05			
ΡØ	1.20					
θ	5°	9°	7°			
θ1	5°	9°	7°			
All Dimensions in mm						



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